



PRODUCT DATA SHEET



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Datasheet

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Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.



General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
55V	1.2Ω	0.3A

Features

- $55V,0.3A, RDS(ON) = 1.2\Omega@VGS = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- G-S ESD Protection Diode Embedded
- ESD protected up to 2KV

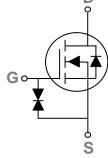
Motor Drive

Applications

- Power Tools
- LED Lighting

SOT-23 Pin Configuration





Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	55	V
V _G s	Gate-Source Voltage	±20	V
Drain Current – Continuous (T _A =25°C)		0.3	А
lD	Drain Current – Continuous (T _A =70°C)	0.16	А
Ірм	Drain Current – Pulsed ¹	0.8	А
D ₋	Power Dissipation (T _A =25°C)	0.35	W
P_{D}	Power Dissipation – Derate above 25°C	0.003	W/°C
Т _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 125	℃

Thermal Characteristics

Symbol	Symbol Parameter		Max.	Unit
Reja	Thermal Resistance Junction to ambient		357	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	55			V
less	Dunin Course Lockers Current	V _{DS} =55V , V _{GS} =0V , T _J =25°C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =40V , V _{GS} =0V , T _J =125°C			100	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±10	uA

On Characteristics

R _{DS(ON)} Static Drain-Source On-Resistance	Static Drain Source On Posictance	V _{GS} =10V , I _D =0.2A	1.2	1.5	Ω	
	V _{GS} =4.5V , I _D =0.1A		1.5	2.5	Ω	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	0.8	1.1	1.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =0.2A		0.5		S

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{2,3}		 3.7	
Q _{gs}	Gate-Source Charge ^{2,3}	V _{DS} =30V , V _{GS} =10V , I _D =0.2A	 0.9	 nC
Q_{gd}	Gate-Drain Charge ^{2, 3}		 0.4	
T _{d(on)}	Turn-On Delay Time ^{2,3}		 3	
Tr	Rise Time ^{2, 3}	V_{DD} =30 V , V_{GS} =10 V , R_{G} =6 Ω	 5	 no
$T_{d(off)}$	Turn-Off Delay Time ^{2,3}	I _D =0.2A	 14	 ns
Tf	Fall Time ^{2,3}		 9	
Ciss	Input Capacitance		 25.5	
Coss	Output Capacitance	V_{DS} =30V , V_{GS} =0V , F =1MHz	 17	 pF
Crss	Reverse Transfer Capacitance		 7.8	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V- V- OV Force Current			0.3	Α
Ism	Pulsed Source Current	V _G =V _D =0V , Force Current			0.6	Α
V_{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =0.2A , T _J =25°C			1.4	V

Note

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 3. Essentially independent of operating temperature.



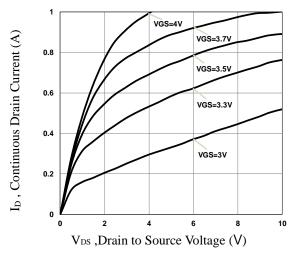


Fig.1 Typical Output Characteristics

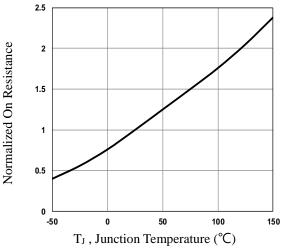


Fig.3 Normalized RDSON vs. T_J

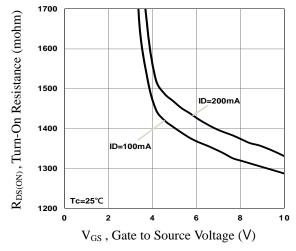


Fig.5 Turn-On Resistance vs. V_{GS}

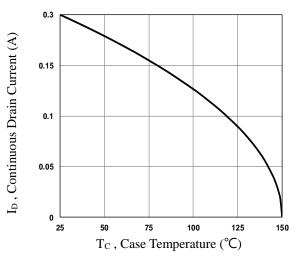


Fig.2 Continuous Drain Current vs. Tc

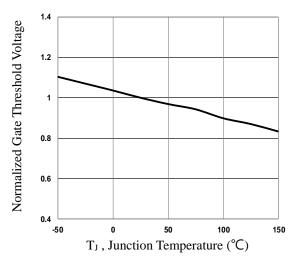


Fig.4 Normalized V_{th} vs. T_J

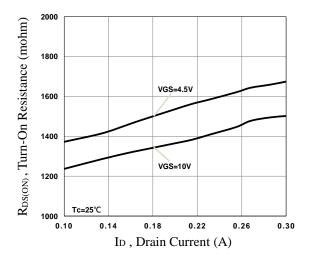


Fig.6 Turn-On Resistance vs. ID



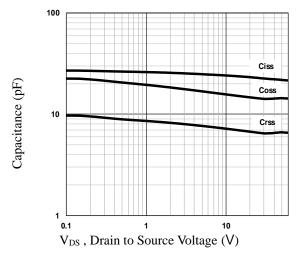
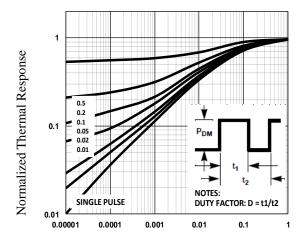


Fig.7 Capacitance Garacteristics



Square Wave Pulse Duration (s)

Fig.9 Normalized Transient

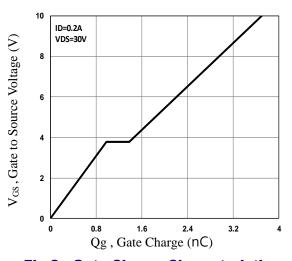
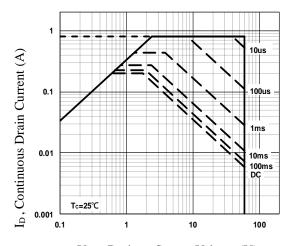


Fig.8 Gate Charge Characteristics

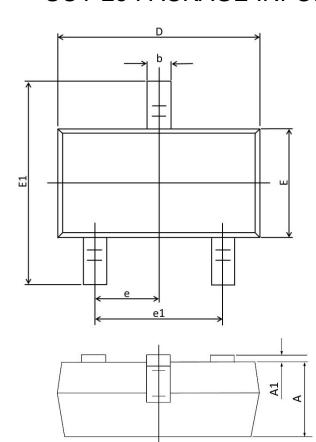


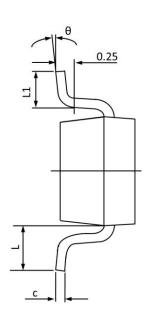
V_{DS} , Drain to Source Voltage (V)

Fig.10 Maximum Safe Operation Area



SOT-23 PACKAGE INFORMATION





Symbol	Dimensions	Dimensions In Millimeters		s In Inches
Symbol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A 1	0.001	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
С	0.080	0.180	0.003	0.008
D	2.700	3.100	0.106	0.122
E	1.100	1.500	0.043	0.059
E1	2.100	2.640	0.080	0.104
е	0.950 TYP.		0.037	7 TYP.
e1	1.780	2.040	0.070	0.080
L	0.550	REF.	0.022 REF.	
L1	0.100	0.500	0.004	0.020
θ	1°	10°	1°	10°



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